L Number	Hits	Search Text	DB	Time stamp
3	2566028	air gap and conductor	USPAT;	2004/06/28 09:08
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
4	123391	(air gap and conductor) and semiconductor	USPAT;	2004/06/28 09:08
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
5	26117	((air gap and conductor) and semiconductor) and polymer	USPAT;	2004/06/28 09:09
			US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
6	6182	(((air gap and conductor) and semiconductor) and polymer) and	USPAT;	2004/06/28 09:09
		decompos\$	US-PGPUB;	-
!			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
7	1440	((((air gap and conductor) and semiconductor) and polymer) and	USPAT;	2004/06/28 09:09
		decompos\$) and interconnect\$	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	
8	451	(((((air gap and conductor) and semiconductor) and polymer) and	USPAT;	2004/06/28 09:10
		decompos\$) and interconnect\$) and capacitance	US-PGPUB;	
			ЕРО; ЛРО;	
			DERWENT;	
			IBM_TDB	